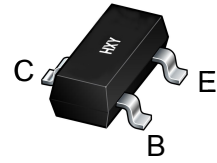




FEATURES

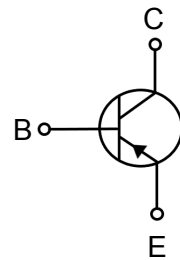
- Collector Current: $I_C=0.6A$
- Power Dissipation of 250mw



SOT-23

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MMBT2907A	SOT-23	2F	3000



MAXIMUM RATINGS (Ta=25 unless otherwise noted)

Parameter	Symbol	Limit	Unit
Collector-Base Voltage	V_{CBO}	-60	V
Collector-Emitter Voltage	V_{CEO}	-40	V
Emitter-Base Voltage	V_{EBO}	-5	V
Collector Current	I_C	-600	mA
Collector Power Dissipation	P_C	250	mW
Thermal Resistance From Junction To Ambient	R_{OJA}	500	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{stg}	-55~+150	°C

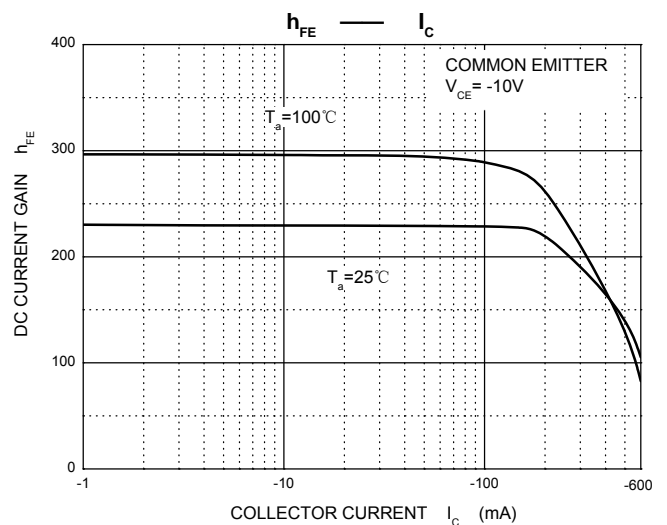
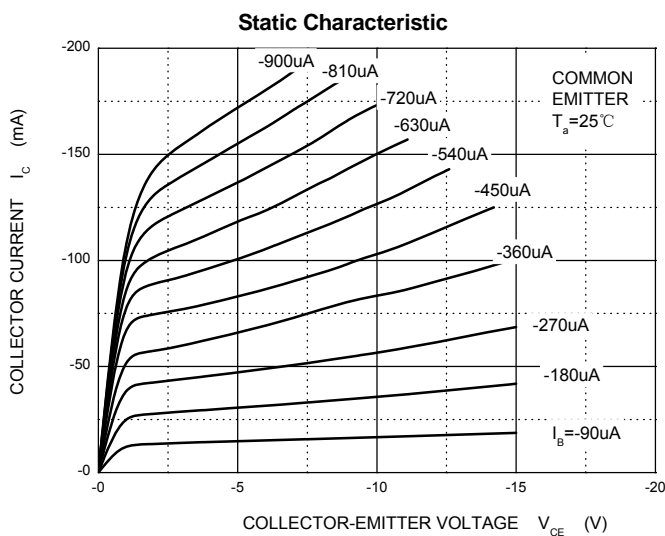


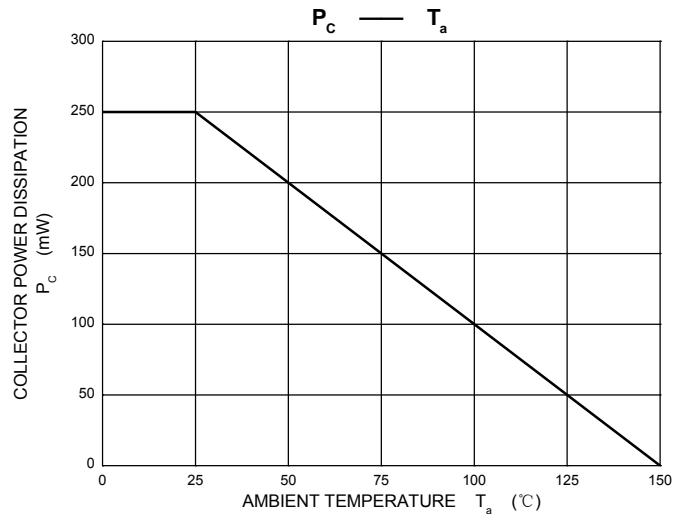
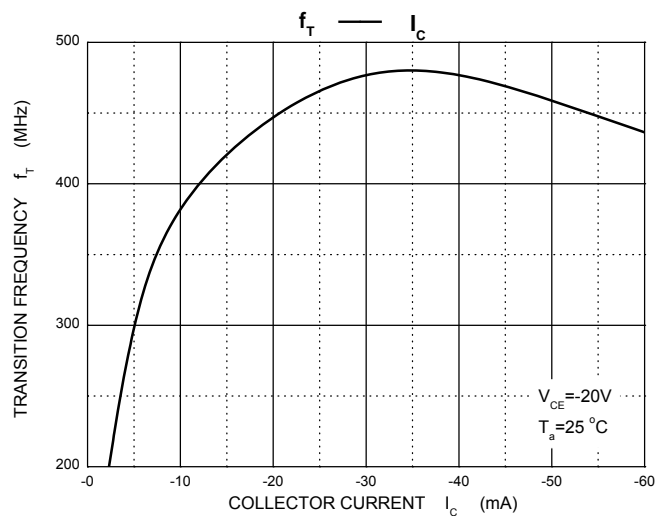
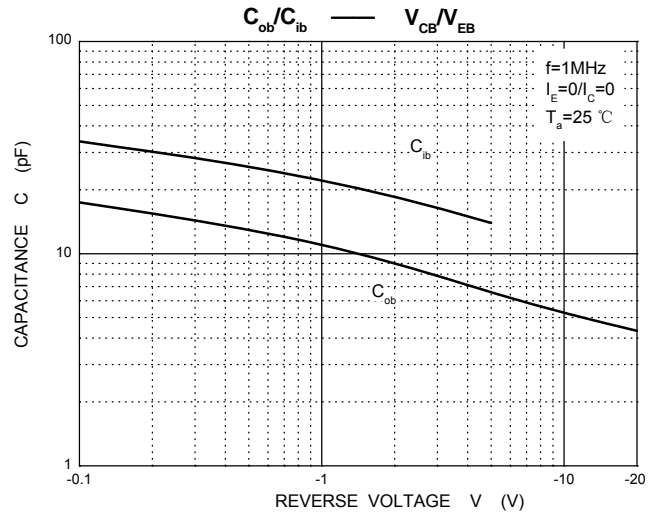
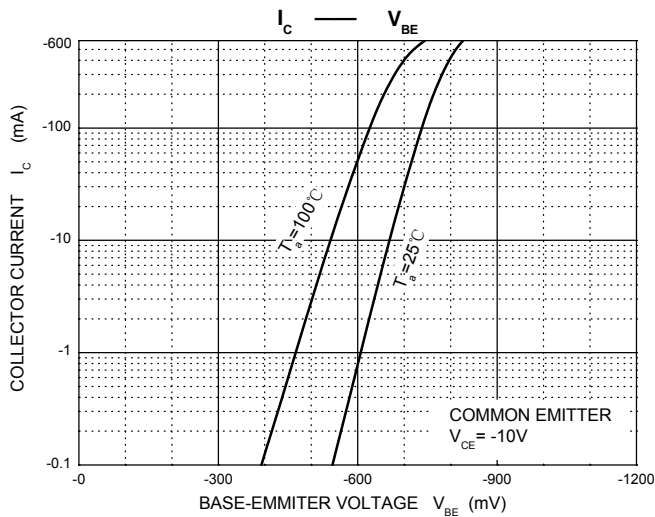
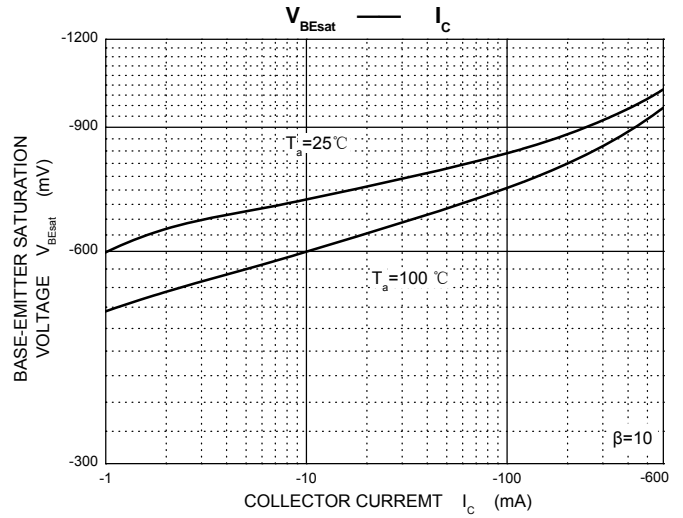
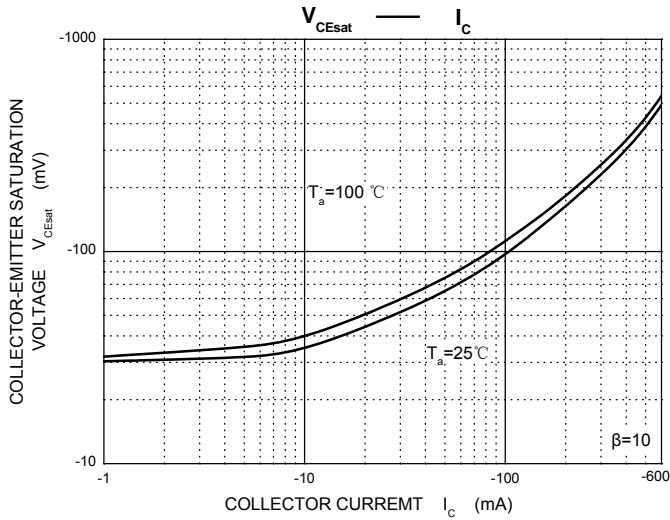
ELECTRICAL CHARACTERISTICS (T_a=25 unless otherwise specified)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =-10μA, I _E =0	-60			V
Collector-emitter breakdown voltage	V _{(BR)CEO*}	I _C =-10mA, I _B =0	-40			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =-10μA, I _C =0	-5			V
Collector cut-off current	I _{CBO}	V _{CB} =-50V, I _E =0			-20	nA
Base cut-off current	I _{EBO}	V _{EB} =-3V, I _C =0			-10	nA
Collector cut-off current	I _{CEX}	V _{CE} =-30 V, V _{BE(off)} =-0.5V			-50	nA
DC current gain	h _{FE(1)*}	V _{CE} =-10V, I _C =-150mA	100		300	
	h _{FE(2)*}	V _{CE} =-10V, I _C =-0.1mA	52			
	h _{FE(3)*}	V _{CE} =-10V, I _C =-500mA	32			
Collector-emitter saturation voltage	V _{CE(sat)*}	I _C =-150mA, I _B =-15mA			-0.4	V
	V _{CE(sat)*}	I _C =-500mA, I _B =-50mA			-0.67	V
Base-emitter saturation voltage	V _{BE(sat)*}	I _C =-150mA, I _B =-15mA			-1	V
	V _{BE(sat)*}	I _C =-500mA, I _B =-50mA			-1.2	V
Transition frequency	f _T	V _{CE} =-20V, I _C =-50mA, f=100MHz	200			MHz
Delay time	t _d	V _{CE} =-30V, I _C =-150mA, I _{B1} =-15mA			10	ns
Rise time	t _r				25	ns
Storage time	t _s	V _{CE} =-6V, I _C =-150mA, I _{B1} =- I _{B2} =- 15mA			225	ns
Fall time	t _f				60	ns

*Pulse test: t_p≤300μs, δ≤0.02.

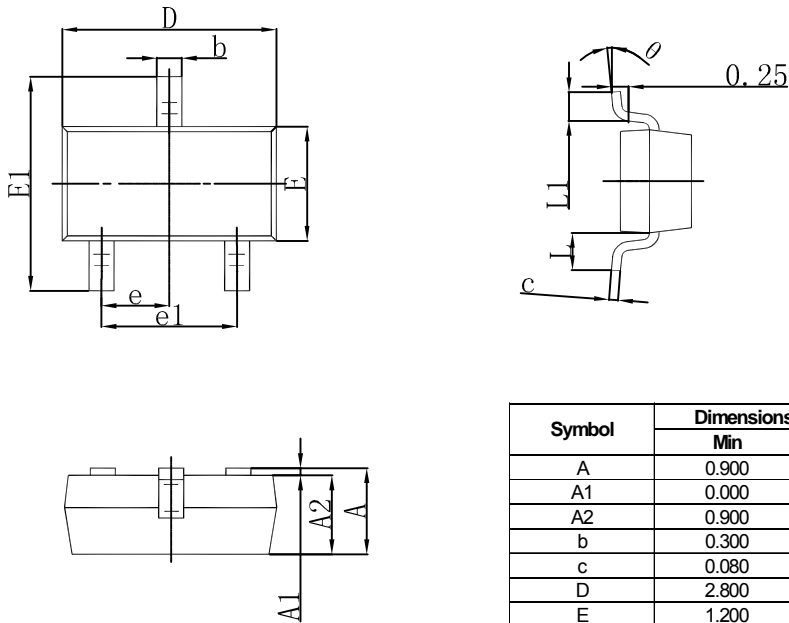
Typical Characteristics





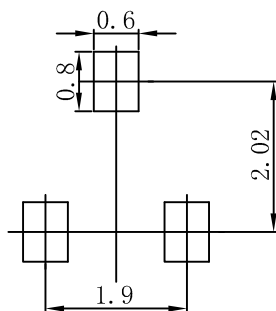


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$.
 3. The pad layout is for reference purposes only.



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